

Announcement

INTERNATIONAL SOCIETY FOR HYBRID MICROELECTRONICS

The International Society for Hybrid Micro-electronics is based in the U.S.A., and there are independent parallel organisations throughout the world. These groups are independent, non-profit-making organisations, the purpose of which is to provide an informal means of discussing and advancing hybrid technology. This is achieved by the organisation of meetings, the publication of a Newsletter and other activities as appropriate. Membership is open to all and there are no formal entry requirements.

All these societies run a programme of meetings throughout the year on subjects concerned with thick films, and interested readers are advised to contact the following Chairmen for details of meetings in their own areas:

1. Benelux

Mr. G. K. Steenvoorden
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3. Germany

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5. Japan

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6. Nordic

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7. U.K.

Mr. A. Fairbairn
Semi-Alloys Inc.
Newbury,
Berkshire,
U.K.

8. U.S.A. — all U.S. Chapters

I.S.H.M.
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In addition, the European Chapters are all linked together through the European Liaison Committee.
Chairman:

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